

## DESIGNED & DIMENSIONED IN MILLIMETERS [INCHES]

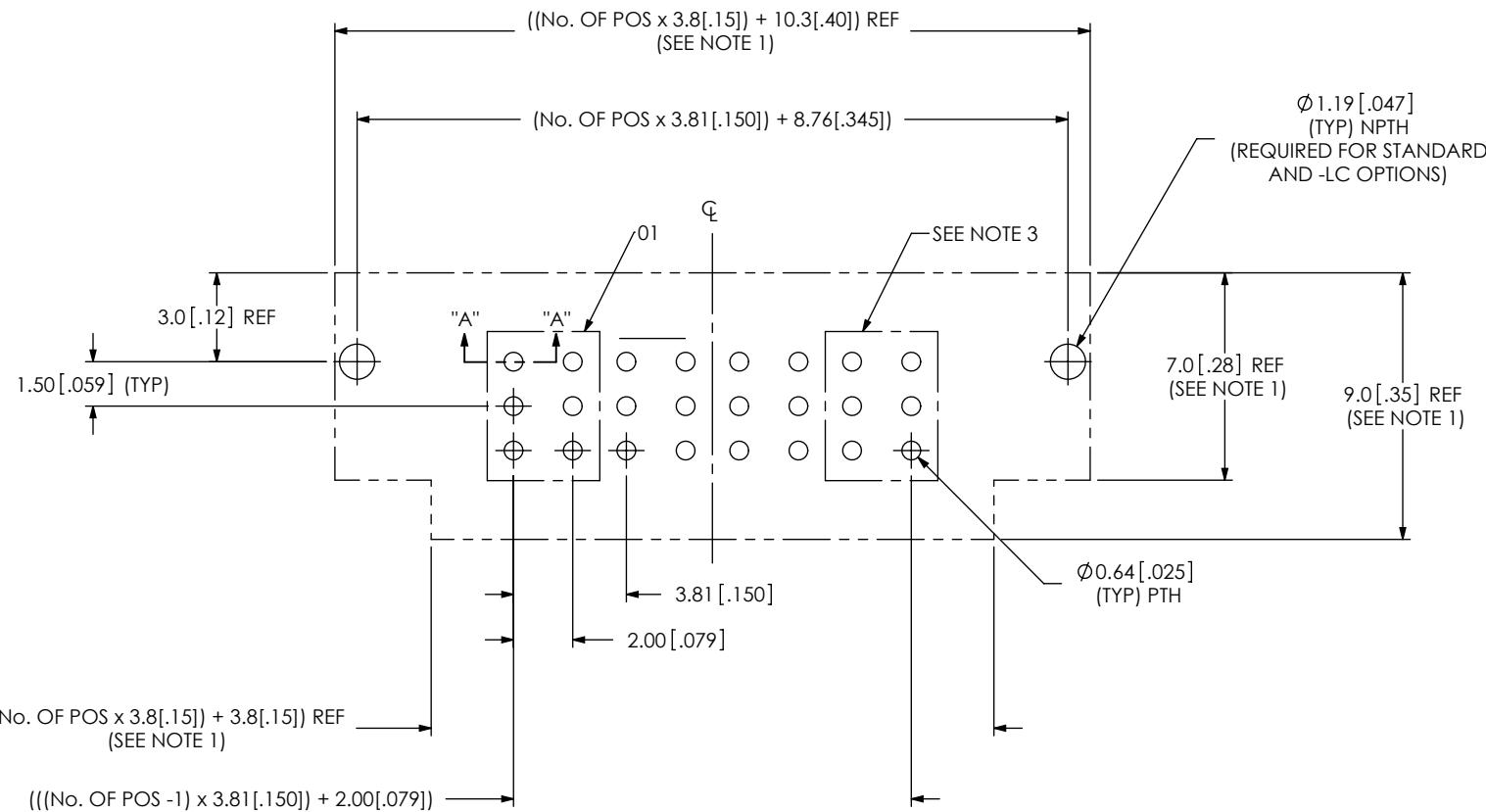


FIG. 1  
(UPT-04-XX.X-XX-X-V-XX SHOWN)

## NOTES:

1. CONNECTOR ENVELOPE DIMENSIONS. OTHER COMPONENTS PLACED ON PCB SHALL AVOID THIS ZONE.
2. ALL DIMENSIONS SYMMETRIC ABOUT THE CENTERLINE.
3. EACH GROUP HOLDS ONE POWER PIN
4. VIAS FOR PRESS-FIT PRODUCT MUST CONFORM TO SPECIFICATIONS SHOWN IN SECTION "A-A"

F:\DWG\MISC\Mktg\Footprnt\UPT-XX-XX.X-XX-X-V-XX-FOOTPRINT.SLDDRW

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520 PARK EAST BLVD, NEW ALBANY, IN 47150  
PHONE: 812-944-6733 FAX: 812-948-5047  
e-Mail: [info@SAMTEC.com](mailto:info@SAMTEC.com) code: 55322

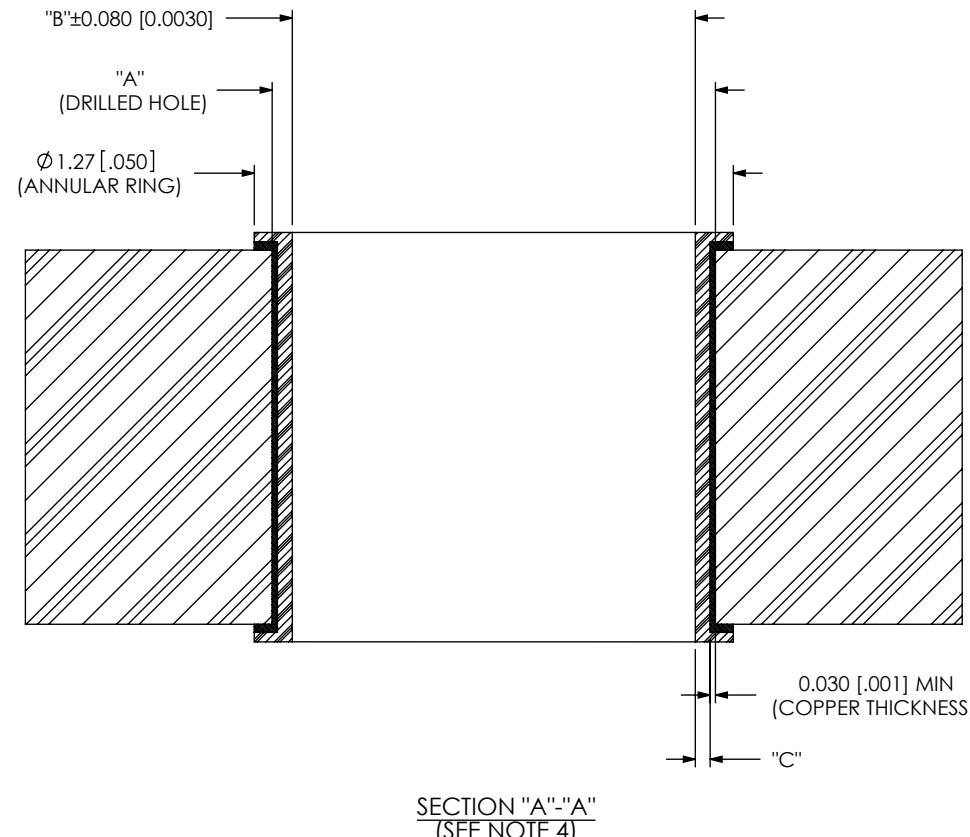


TABLE 1

PLATING	"A"+/-0.001	"B"+/-0.003	"C"
HOT AIR LEVEL TIN	0.74 [0.029]	0.64 [0.025]	0.015 [.006] MAX TIN
ELECTROLESS GOLD OVER NICKEL	0.74 [0.029]	0.64 [0.025]	.0025 - .0076 [.0001 - .0003] NICKEL / .00005 - .00020 (.000002 - .000008) GOLD
ORGANIC SURFACE PROTECTANT COPPER	0.71 [0.028]	0.64 [0.025]	NA

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SHEET SCALE: 4:1

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520 PARK EAST BLVD, NEW ALBANY, IN 47150  
PHONE: 812-944-6733 FAX: 812-948-5047  
e-Mail: info@SAMTEC.com code: 55322

DESCRIPTION:  
MICRO POWER TERMINAL FOOTPRINT

DWG. NO.  
UPT-XX-XX.X-XX-X-V-XX-FOOTPRINT

BY: B RAY 08/25/2008 SHEET 2 OF 2